

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ANTHONY M. CHIU	01/11/2005
TONG YAN TEE	08/11/2005
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	10954630
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ATTORNEY DOCKET NUMBER:	03-C-129US01
NAME OF SUBMITTER:	PATRICK C. R. HOLMES
SIGNATURE:	/Patrick C. R. Holmes/
DATE SIGNED:	06/24/2016
Total Attachments: 3	
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ASSIGNMENT

WHEREAS, We, Anthony M. Chiu, resident and citizen of the United States of America, and Tong Yan Tee, resident of Singapore and citizen of Malaysia, have invented certain new and useful improvements in "COPPER INTERPOSER FOR REDUCING WARPING OF INTEGRATED CIRCUIT PACKAGES AND METHOD OF MAKING IC PACKAGES" disclosed in an application for United States Letters Patent (Application No. 10/954,630 filed September 30, 2004);

WHEREAS, STMICROELECTRONICS, INC., a corporation organized under the laws of the state of Delaware, having a place of business at 1310 Electronics Drive, Carrollton, Texas 75006 (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or to its successors, assigns and legal representatives, any facts known to us respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

Date: Jan 11, 2005

Anthony M. Chiu
Anthony M. Chiu


Date: _____

Tong Yan Tee

Date: _____

Anthony M. Chiu

Date: Aug 11, 2005



Tong Yan Tee